



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(ON) Max	I _D T _A = +25°C
20V	$24m\Omega$ @ $V_{GS} = 4.5V$	7A
200	28mΩ @ V _{GS} = 2.5V	5A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Backlighting
- DC-DC Converters
- Power Management Functions

Features and Benefits

- Low On-Resistance
- Low-Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN2024UVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

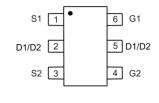
Mechanical Data

- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 63
- Weight: 0.013 grams (Approximate)

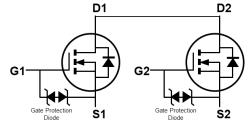




TSOT26



Top View



Equivalent Circuit

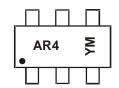
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2024UVTQ-7	TSOT26	3,000/Tape & Reel
DMN2024UVTQ-13	TSOT26	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



 $\begin{array}{l} \mathsf{AR4} = \mathsf{Product} \; \mathsf{Type} \; \mathsf{Marking} \; \mathsf{Code} \\ \mathsf{YM} = \mathsf{Date} \; \mathsf{Code} \; \mathsf{Marking} \\ \mathsf{Y} \; \mathsf{or} \; \overline{\mathsf{Y}} = \mathsf{Year} \; (\mathsf{ex:} \; \mathsf{I} = 2021) \\ \mathsf{M} = \mathsf{Month} \; (\mathsf{ex:} \; 9 = \mathsf{September}) \end{array}$

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н	ı	J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	VDSS	20	V
Gate-Source Voltage	Vgss	±10	V
Continuous Drain Current (Note 6) VGS = 4.5V	lD	7.0 5.0	А
Maximum Continuous Body Diode Forward Curr	Is	2.3	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle =	I _{DM}	35	Α

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{OJA}	124	°C/W
Total Power Dissipation (Note 6)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Rөja	78	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

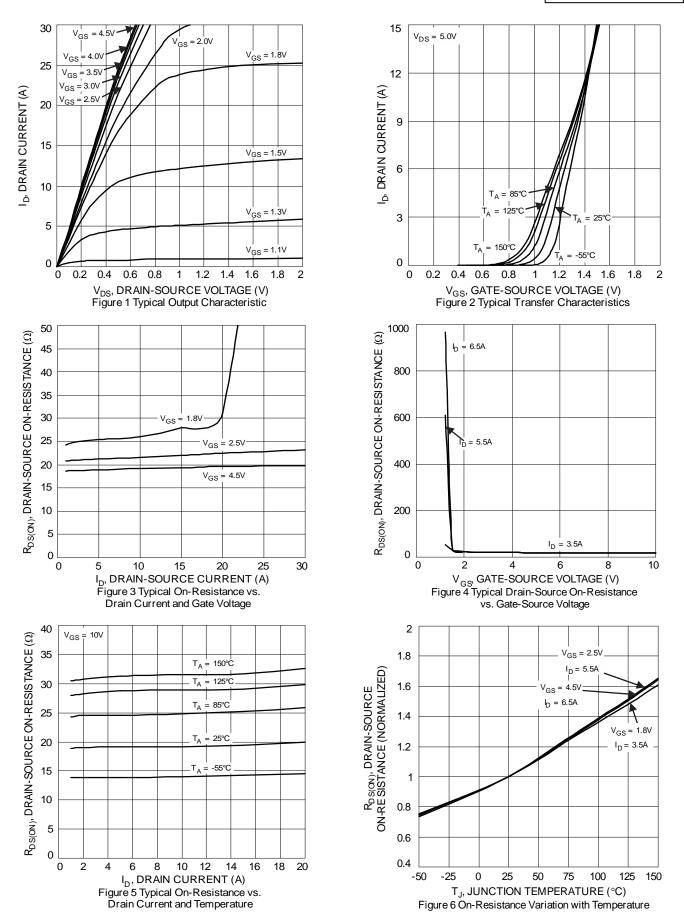
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1.0	μΑ	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(TH)	0.5	_	0.9	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
			19	24		$V_{GS} = 4.5V, I_{D} = 6.5A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	22	28	$m\Omega$	Vgs = 2.5V, ID = 5.5A
			25	34		V _G S = 1.8V, I _D = 3.5A
Diode Forward Voltage	VsD	_	0.9	1.2	V	$V_{GS} = 0V$, $I_D = 5A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	647	_	рF	101/11/01/01/
Output Capacitance	Coss	_	78	_	pF	V _{DS} = 10V, V _{GS} = 0V -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	38	1	pF	1 = 1.01/11/12
Gate Resistance	R_g	100	400	800	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge	Qg	_	7.1		nC	
Gate-Source Charge	Qgs	_	0.9	_	nC	VGS = 4.5V, VDS = 10V, ID = 6.5A
Gate-Drain Charge	Q_{gd}	_	0.7	_	nC	
Turn-On Delay Time	tD(ON)	_	98	_	ns	
Turn-On Rise Time	t _R	_	140	_	ns	V _{DS} = 10V, V _{GS} = 4.5V,
Turn-Off Delay Time	tD(OFF)	_	1024	_	ns	$R_L = 10\Omega$, $R_G = 6\Omega$, $I_D = 1A$
Turn-Off Fall Time	tF	_	434		ns	
Reverse Recovery Time	trr	_	245	_	ns	IF = 1.0A, di/dt = 100A/µs
Reverse Recovery Charge	Q_{RR}		149	_	nC	I _F = 1.0A, di/dt = 100A/μs

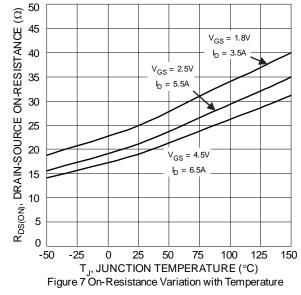
Notes:

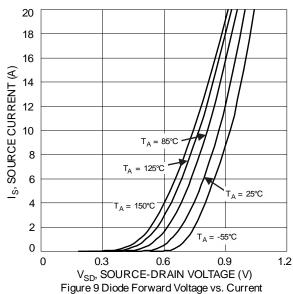
- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on 1" x 1" FR-4 PCB with high-coverage 2oz. copper, single sided.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

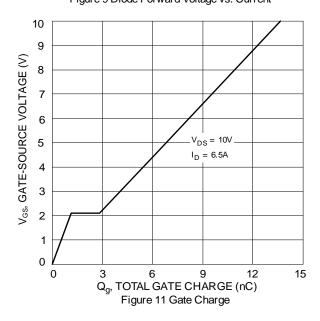












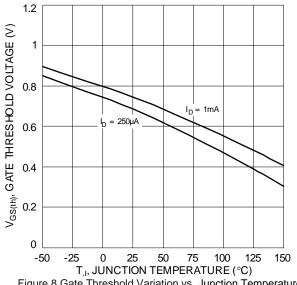
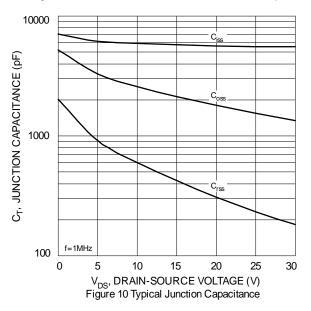
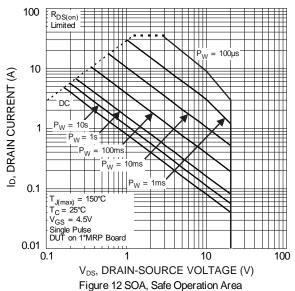
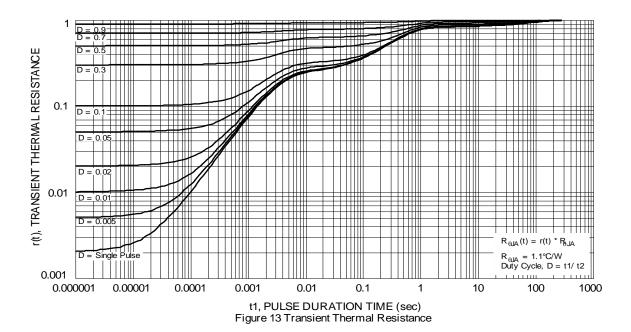


Figure 8 Gate Threshold Variation vs. Junction Temperature







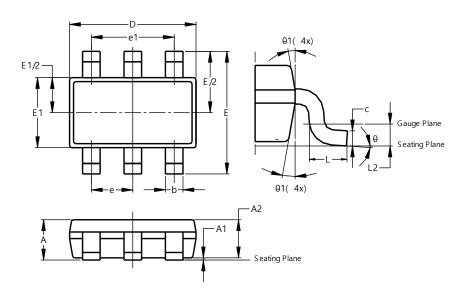




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26

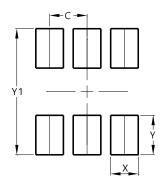


TSOT26							
Dim	Min Max Typ						
Α	-	1.00	_				
A1	0.010	0.100	-				
A2	0.840	0.900	_				
D	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.700	1.600				
b	0.300	0.450	-				
С	0.120	0.200	-				
е	0.950 BSC						
e1	1.900 BSC						
L	0.30 0.50 -						
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3 200



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